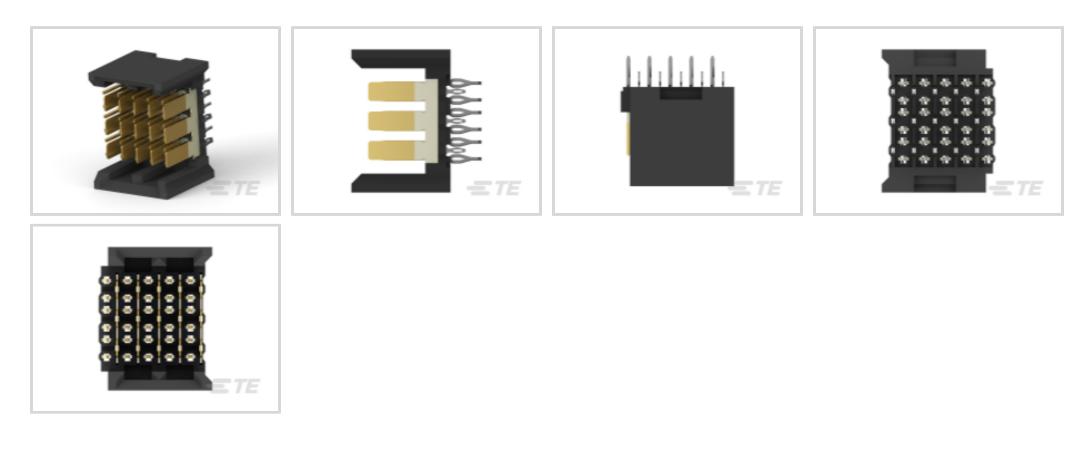


Z-PACK | Z-PACK HS3

TE Internal #: 5120732-1 High Speed Backplane Connectors, 30 Position, Mating Alignment, Polarization Mating Alignment Type, 6 Row, 5 Column, PCB Mount Header, Z-PACK HS3

View on TE.com >

Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Connector System: Board-to-Board Number of Positions: 30 Row-to-Row Spacing: 2 mm [.078 in] Mating Alignment: With Mating Alignment Type: Polarization

Features



Product Type Features

Backplane Module Type	Center
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Partially Shrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
Backplane Architecture	Traditional Backplane
Number of Positions	30
Number of Rows	6
Number of Columns	5
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	250 VAC

High Speed Backplane Connectors, 30 Position, Mating Alignment, Polarization Mating Alignment Type, 6 Row, 5 Column, PCB Mount Header, Z-PACK HS3



Signal Characteristics

Number of Differential Pairs per Column	3
Body Features	
Primary Product Color	Black
Contact Features	
Contact Mating Area Length	6.8 mm[.268 in]
Contact Type	Pin
Contact Mating Area Plating Material Thickness	.5 μm[19.68 μin]
Contact Mating Area Plating Material	Tin
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Dual Beam
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	1.15 A
Termination Features	
Termination Post & Tail Length	3.7 mm[.146 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

Mechanical Attachment

Guide Hardware	Without
Mating Retention	Without
PCB Mount Retention	With
PCB Mount Retention Type	Action/Compliant Tail
Mating Alignment	With
Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	2
Housing Material	Polyester - GF
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
Connector Length	12.41 mm[.489 in][.945 in]
Connector Height	11.8 mm[.47 in]

High Speed Backplane Connectors, 30 Position, Mating Alignment, Polarization Mating Alignment Type, 6 Row, 5 Column, PCB Mount Header, Z-PACK HS3



Connector Width	24 mm
PCB Thickness (Recommended)	1.4 mm
PCB Hole Diameter	.05 mm[.001 in]
Row-to-Row Spacing	2 mm[.078 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Compliant

Product Compliance Disclaimer

EU ELV Directive 2000/53/EC

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

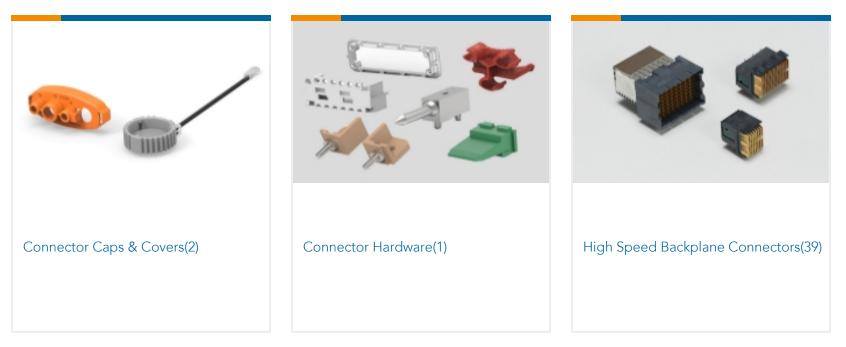
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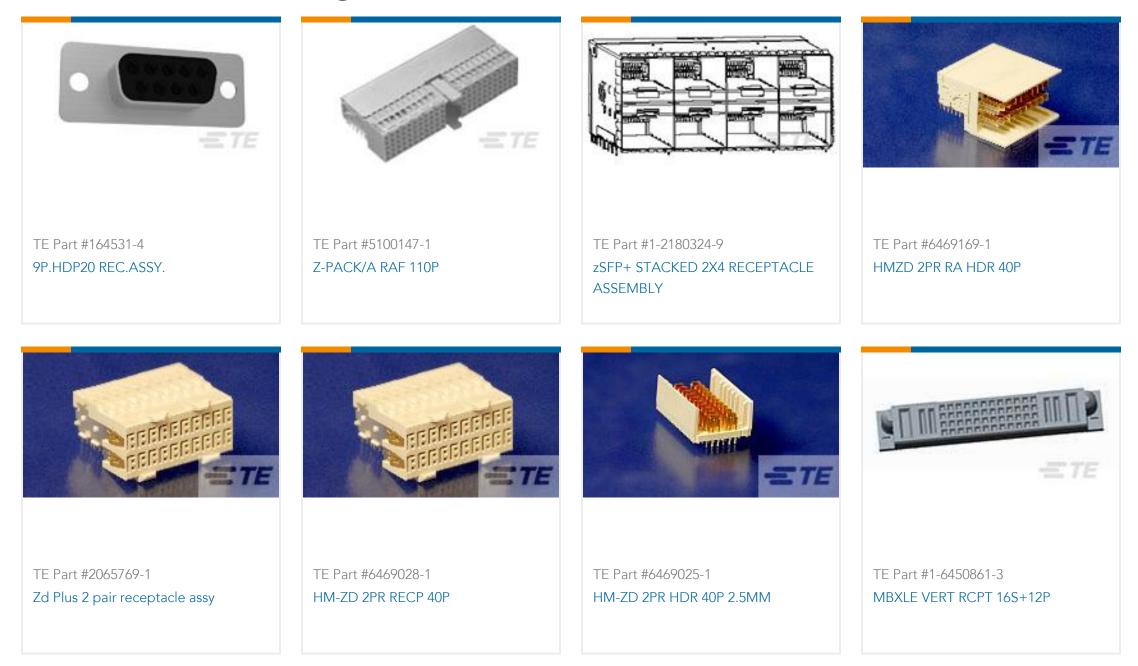
Compatible Parts



Also in the Series Z-PACK HS3



Customers Also Bought



High Speed Backplane Connectors, 30 Position, Mating Alignment, Polarization Mating Alignment Type, 6 Row, 5 Column, PCB Mount Header, Z-PACK HS3





Documents

Product Drawings Z-PACK HS3 HDR ASSY 6R 30P

English

CAD Files

Customer View Model ENG_CVM_CVM_5120732-1_B.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5120732-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5120732-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages High Speed Backplane Connectors catalog - Z-PACK HS3 Connector

English

Product Specifications Application Specification

English